

MPSH24/MMBTH24

NPN General Purpose Amplifier

- This device is designed for common-emitter low noise amplifier and mixer applications with collector currents in the 100mA to 20mA range to 300MHz, and low frequency drift common-base VHF oscillator applications with high output levels for driving FET mixers.
- TO-92



- Sourced from process 47.
- See MPSH11 for characteristics.

1. Base 2. Emitter 3. Collector 1. Base 2. Emitter 3. Collector

Absolute Maximum Ratings $T_C=25^{\circ}C$ unless otherwise noted

Symbol	Parameter	Value	Units
V _{CEO}	Collector-Emitter Voltage	30	V
V _{CBO}	Collector-Base Voltage	40	V
V _{EBO}	Emitter-Base Voltage	4.0	V
I _C	Collector current - Continuous	50	mA
T _J , T _{sta}	Junction and Storage Temperature	-55 ~ +150	°C

Electrical Characteristics T_C=25°C unless otherwise noted

Symbol	Parameter	Test Condition	Min.	Тур.	Max.	Units	
Off Characte	Off Characteristics						
V _{(BR)CEO}	Collector-Emitter Sustaining Voltage *	$I_C = 1.0 \text{mA}, I_B = 0$	30			V	
V _{(BR)CBO}	Collector-Base Breakdown Voltage	$I_C = 100 \mu A, I_E = 0$	40				
V _{(BR)EBO}	Emitter-Base Breakdown Voltage	$I_E = 10\mu A, I_C = 0$	4.0			VV	
I _{CBO}	Collector Cutoff Current	$V_{CB} = 15V, I_{E} = 0$			50	nA	
On Characte	On Characteristics						
h _{FE}	DC Current Gain	$I_C = 8.0 \text{mA}, V_{CE} = 10 \text{V}$	30				
Small Signal Characteristics							
f _T	Current Gain Bandwidth Product	I _C = 8.0mA, V _{CE} = 10V, f = 100MHz	400			MHz	
C _{cb}	Collector-Base Capacitance	$V_{CB} = 10V, I_E = 0, f = 1.0MHz$			0.36	pF	

^{*} Pulse Test: Pulse Width $\leq 300 \mu s$, Duty Cycle $\leq 2.0\%$

Thermal Characteristics T_A=25°C unless otherwise noted

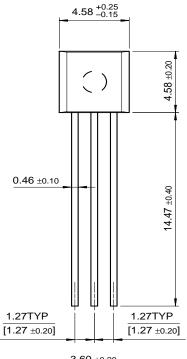
Symbol	Parameter	Ma	Units	
	Farameter	MPSH24	*MMBTH24	Units
P _D	Total Device Dissipation	625	225	mW
	Derate above 25°C	5.0	1.8	mW/°C
$R_{ heta JC}$	Thermal Resistance, Junction to Case	83.3		°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	200	556	°C/W

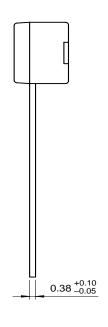
^{*} Device mounted on FR-4 PCB 1.6" \times 1.6" \times 0.06"

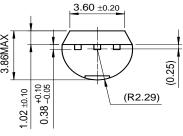
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Package Dimensions

TO-92





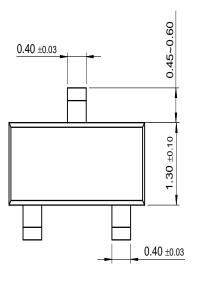


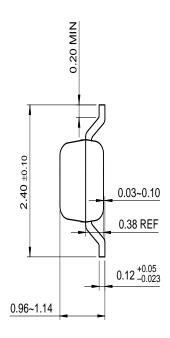
Dimensions in Millimeters

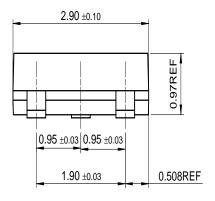
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Package Dimensions (Continued)

SOT-23







Dimensions in Millimeters

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